

2.45GHz ULTRA COMPACT CHIP ANTENNA DATA GUIDE

DESCRIPTION

The exciting ANT-2.45-CHP is one of the world's smallest high-performance 2.4GHz Chip Antennas. It is ideal for all 2.4GHz applications including Bluetooth, 802.11, Home RF, ZigBee and other popular standards. The antenna uses advanced Low Temperature Co-fired Ceramic (LTCC) technology and a proprietary element to achieve superior size and performance characteristics. The tiny SMD package measures a mere 6.5mm (L) x 2.2mm (W) x 1.0mm (H) and is compatible with handand reflow-assembly. Favorable electrical specifications, stability, and outstanding cost-effectiveness make it the logical choice for a wide variety of applications.

FEATURES

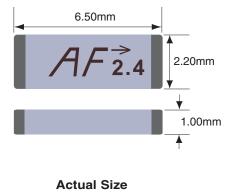
- Incredibly compact SMD package
- Superior LTCC technology
- **50** Ω characteristic impedance
- Low loss
- Wide bandwidth
- Favorable linear polarization
- > Unity gain

APPLICATIONS

Any 2.4GHz wireless product including:

- Bluetooth
- 802.11
- ZigBee
- Wireless PCMCIA Cards
- Telemetry
- Data Collection
- Industrial Process Monitoring
- Compact Wireless Products
- External Antenna Elimination

PHYSICAL DIMENSIONS



No external matching required

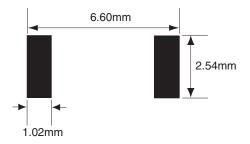
- Highly stable over temperature and humidity
- Fully hand- and reflow-assembly compatible
- Cost-effective

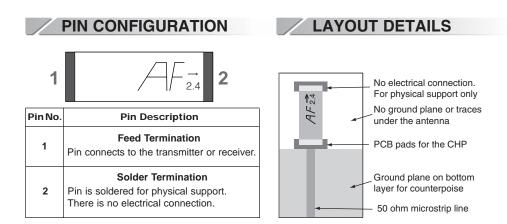
ORDERING INFORMATION					
PART #	DESCRIPTION				
ANT-2.45-CHP-x	5-CHP-x 2.45GHz Ultra-Compact Chip Antenna				
x= "T" for Tape/Reel, "B" for Bulk					
Standard Reel is 3,000 pcs. Quantities less than 3,000 pcs. supplied n bulk.					

PHYSICAL SPECIFICATIONS				
Dimensions (mm)	6.5(L) x 2.2(W) x 1.0(H)			
Operating/Storage Temperature	-40~+85°C			
Construction	LTCC			

ELECTRICAL PERFORMANCE				
Center Frequency	2.45GHz			
Bandwidth	180.0MHz			
Pattern	Omni-directional			
Polarization	Linear			
VSWR	<u>≤</u> 2.0 (Max.)			
Maximum Gain	+0.5dBi			
Impedance	50Ω			
Power Handling	3W (Max.)			

PAD LAYOUT





ASSEMBLY CONSIDERATIONS

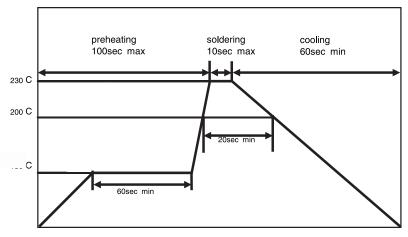
The antenna is designed to support hand or automated assembly. To avoid damage to the part, the reflow/solder guidelines found below should be carefully followed. The antenna is single ended meaning that one pad is electrically connected while the other is for mechanical support only. The antenna terminals are not interchangeable so polarity must be observed during assembly.

Hand Soldering

This antenna is designed for high-volume automated assembly, however, it may be successfully attached by hand assembly techniques. A hand-solder temperature of 225° or lower should be used. Do not exceed a 10 sec. heating time.

Reflow Temperature Profile

The single most critical stage in the automated assembly process is the reflow process. The reflow profile below should be closely followed since excessive temperatures or transport times during reflow will irreparably damage the antennas. Assembly personnel will need to pay careful attention to the oven's profile to ensure that it meets the requirements necessary to successfully reflow all components while still meeting the limits mandated by the antennas themselves.



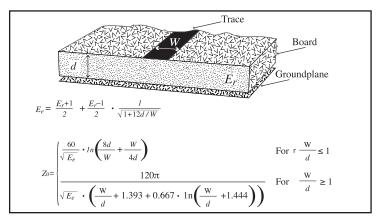
REFLOW SOLDERING PROFILE

Absolute Maximum Solder Times Hand-Solder Temp. TX +225°C for 10 Sec. Hand-Solder Temp. RX +225°C for 10 Sec. Recommended Solder Melting Point +180°C Reflow Oven: +220°C Max. (See adjoining diagram)

LAYOUT CONSIDERATIONS

The antenna's wide bandwidth and good stability allow it to perform well and accommodate differing layout requirements. Despite this, proper layout is vital to ensure correct operation. Improper placement of planes, traces or system components will result in nulls or complete detuning. Failure by the designer to respect and account for these requirements will result in unsatisfactory performance. Ideally the antenna will be mounted on the board in such a way as to allow an unobstructed field of view. The area under the backside of the antenna must be free of components, traces, and planes. Components may be placed to the rear of the antenna in the ground plane counterpoise area. The feed trace from the RF stage to the antenna must be a microstrip trace or coax transmission line and should be kept as short as practical.

Two sample layouts and their associated data are illustrated on the following pages. They are intended to be representative and it is not necessary to follow them precisely. They do however, exhibit layout techniques and the differences that occur with differing size PCB's and layouts. After your own layout is complete the performance of the antenna in your specific product should be carefully checked using tools like a network analyzer. In some cases the size of the product's PCB, proximity of the case or other factors may make a custom version of the antenna necessary. You may contact Antenna Factor for more information.

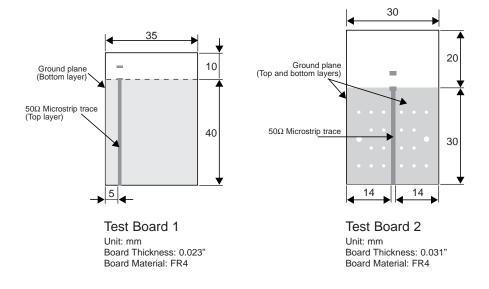


MICROSTRIP CALCULATIONS

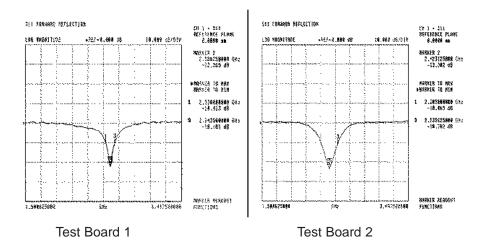
Microstrip Formulas (Er = Dielectric constant of PC board material)

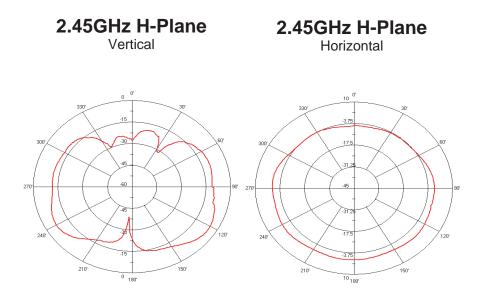
Dielectric Constant	Width/Height (W/d)	Effective Dielectric Constant	Characteristic Impedance
4.8	1.8	3.59	50.0
4	2	3.07	51.0
2.55	3	2.12	48.0

TEST BOARD PATTERNS



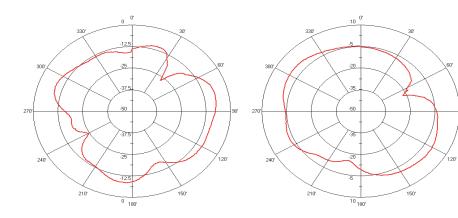
RETURN LOSS

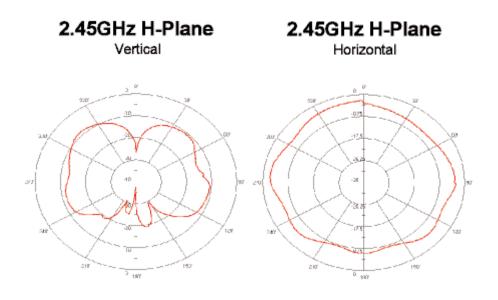




2.45GHz E-Plane Vertical

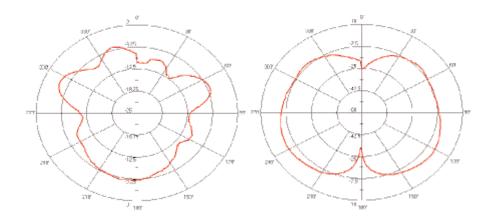
2.45GHz E-Plane Horizontal





2.45GHz E-Plane Vertical

2.45GHz E-Plane Horizontal





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